

AFE4950 Ultra-Small, Integrated AFE for Wearable Optical Heart-Rate Monitoring, SpO₂ and Electrical Bio-sensing

1 Features

- Supports simultaneous & synchronized acquisition of up to 24 PPG and a single-lead ECG signal.
- Flexible allocation of 8 LED, 4 PD in each phase
- ECG signal chain:
 - 1-lead ECG signal acquisition up to 2 kHz
 - RLD output to drive a third electrode
 - Input noise : 0.7 μ V-rms
 - Supports up to +/- 0.65 V differential DC offset and +/-0.55 V common mode range
 - Programmable INA gain: 11, 21
 - High-pass filter with quick saturation recovery
 - Integrated 300 Hz anti-aliasing low pass filter
 - AC, DC lead-off detect: 3.125-nA to 100-nA
 - Low power continuous lead-on detection
- Impedance signal chain
 - Continuous low-power monitoring of impedance between 2 electrodes
 - 7 M Ω range with 1 k Ω accuracy
- PPG Transmitter:
 - 8-Bit Programmable LED Current with range adjustable from 25 mA to 250 mA
 - Mode to fire two LEDs in parallel
 - Support of 8 LEDs in Common Anode configuration for SpO₂, Multi-Wavelength HRM
- PPG Receiver:
 - 2 parallel receivers (two sets of TIA/ filter)
 - Supports 4 Time-Multiplexed Photodiode Inputs to each Receiver
 - 8-bit Ambient Offset subtraction at each TIA input with 256 μ A range
 - 8-bit LED Offset Subtraction DAC with 64 μ A range
 - Automatic ambient cancellation and dynamic LED DC cancellation at TIA input
 - Ambient rejection close to 100 dB up to 10 Hz
 - Noise filtering with programmable bandwidth
 - Trans-impedance Gain: 3.7 k Ω to 1 M Ω
- Accurate, Continuous Heart-Rate Monitoring:
 - System SNR up to 109-dB at 16 μ A PD current
 - Low Current for Continuous Operation on a Wearable Device with a Typical Value: 15- μ A for an LED, 20- μ A for the Receiver

- External clock and internal oscillator modes
- Acquire data synchronized with system master clock
- FIFO with 256-sample Depth
- SPI, I²C interfaces: Selectable by pin
- 2.6-mm $\times$ 2.5-mm DSBGA, 0.4-mm Pitch
- Supplies: Rx:1.7-1.9V (LDO Bypass); 1.9-3.6V (LDO Enabled), Tx:3-5.5V, IO:1.7-RX_SUP

2 Applications

- Optical Heart-Rate Monitoring (HRM) for Wearables, Hearables
- High performance ECG signal acquisition
- Synchronized PPG, ECG for BP estimation
- Heart-rate variability (HRV)
- Pulse oximetry (SpO₂) measurements

3 Description

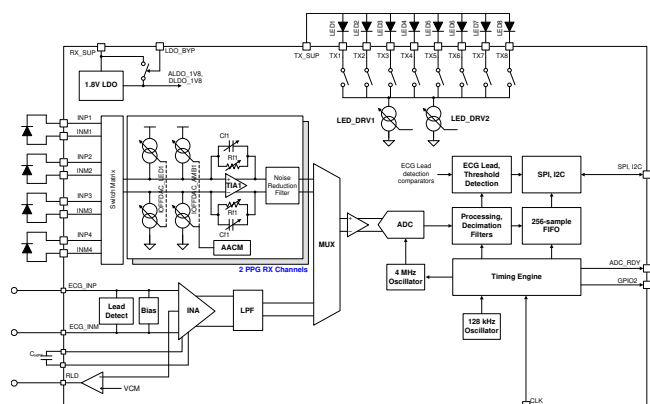
The AFE4950 device is an analog front-end (AFE) for synchronized signal acquisition of PPG and ECG signals. The device can also be used for optical bio-sensing applications, such as heart-rate monitoring (HRM) and saturation of peripheral capillary oxygen (SpO₂). The ECG signal chain supports 2- and 3-electrode configurations and has an integrated Right leg drive (RLD) buffer.

Device Information⁽¹⁾

PART NUMBER	PACKAGE	BODY SIZE (NOM)
AFE4950	DSBGA (36)	2.60 mm $\times$ 2.50 mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

Simplified Schematic



4 Description (continued)

The ECG signal chain can also be used to do a continuous, low-power monitoring of the impedance between a pair of electrodes. The AFE also has a fully-integrated LED driver with an 8-bit current control. The device has a high dynamic range transmit-and-receive circuitry that helps with the sensing of very small signal levels.

5 Device and Documentation Support

5.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

5.2 Support Resources

[TI E2E™ support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

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5.3 Trademarks

E2E is a trademark of Texas Instruments.

All other trademarks are the property of their respective owners.

5.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

5.5 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

6 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
PAFE4950YBGR	ACTIVE	DSBGA	YBG	36	3000	TBD	Call TI	Call TI	-40 to 85		Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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